

MOSFET - N-Channel, QFET

800 V, 12.6 A, 750 m Ω

FQA13N80-F109

Description

This N-Channel enhancement mode power MOSFET is produced using onsemi's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 12.6 A, 800 V, $R_{DS(on)} = 750 \text{ m}\Omega$ (Max.) @ $V_{GS} = 10 \text{ V}$, $I_D = 6.3 \text{ A}$
- Low Gate Charge (Typ. 68 nC)
- Low C_{rss} (Typ. 30 pF)
- 100% Avalanche Tested
- This is Pb-Free and Halide Free Device

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

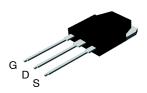
Symbol	Parameter	Value	Unit
V _{DSS}	Drain to Source Voltage	800	V
I _D	Drain Current –Continuous ($T_C = 25$ °C) –Continuous ($T_C = 100$ °C)	12.6 8.0	A A
I _{DM}	Drain Current -Pulsed (Note 1)	50.4	Α
V _{GSS}	Gate-Source Voltage	±30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	1100	mJ
I _{AR}	Avalanche Current (Note 1)	12.6	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)	30	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.0	V/ns
P _D	Power Dissipation (T _C = 25°C) -Derate Above 25°C	300 2.38	W W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	–55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purposes, 1/8" from Case for 5 seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

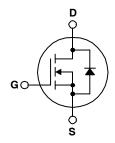
1

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. L = 13 mH, I_{AS} = 12.6 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25 °C. 3. $I_{SD} \le$ 12.6 A, di/dt \le 200 A/ μ s, $V_{DD} \le$ BV $_{DSS}$, Starting T_J = 25 °C.

V _{DSS}	R _{DS(on)} MAX	I _D MAX	
800 V	750 mΩ @ 10 V	12.6 A	

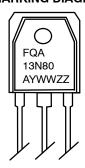


TO-3P-3I D CASE 340BZ



N-CHANNEL MOSFET

MARKING DIAGRAM



FQA13N80 YWW

ZΖ

= Specific Device Code = Assembly Location

= Date Code (Year & Week) = Assembly Lot

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.42	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.24	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W

$\textbf{ELECTRICAL CHARACTERISTICS} \ (T_C = 25^{\circ}C \ unless \ otherwise \ noted)$

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OFF CHARA	ACTERISTICS	•	•	•	•	
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	800	-	_	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C	-	0.95	_	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 800 V, V _{GS} = 0 V	-	-	10	μΑ
		V _{DS} = 640 V, T _C = 125°C	-	-	100	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	-100	nA
ON CHARA	CTERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0	-	5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 6.3 A	-	0.58	0.75	Ω
9FS	Forward Transconductance	V _{DS} = 50 V, I _D = 6.3 A	-	13	-	S
DYNAMIC C	HARACTERISTICS		-			-
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	2700	3500	pF
C _{oss}	Output Capacitance	1	_	275	360	pF
C _{rss}	Reverse Transfer Capacitance	1	_	30	39	pF
SWITCHING	CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 400 V, I _D = 12.6 A,	_	60	130	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$ (Note 4)	_	150	310	ns
t _{d(off)}	Turn-Off Delay Time	(1000 1)	-	155	320	ns
t _f	Turn-Off Fall Time	1	-	110	230	ns
Qg	Total Gate Charge	V _{DS} = 640 V, I _D = 12.6 A,	-	68	88	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V (Note 4)	-	15	-	nC
Q _{gd}	Gate-Drain Charge		_	32	_	nC
DRAIN-SOU	RCE DIODE CHARACTERISTICS AND N	IAXIMUM RATINGS				
I _S	Maximum Continuous Drain-Source Diode Forward Current		-	_	12.6	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		-	-	50.4	Α
V_{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 12.6 A	-	-	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 12.6 A,	-	850	-	ns
Q _{rr}	Reverse Recovery Charge	dl _F /dt = 100 A/μs	_	11.3	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially Independent of Operating Temperature.

TYPICAL CHARACTERISTICS

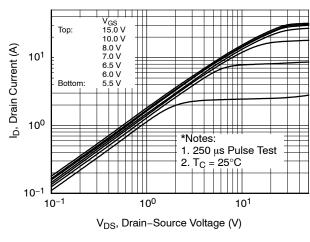


Figure 1. On-Region Characteristics

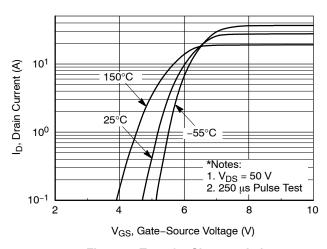


Figure 2. Transfer Characteristics

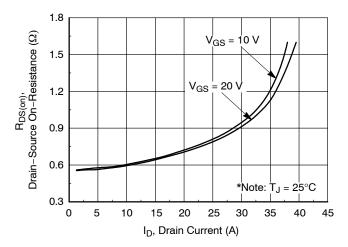


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

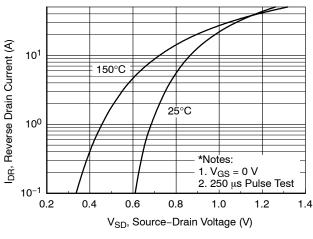


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

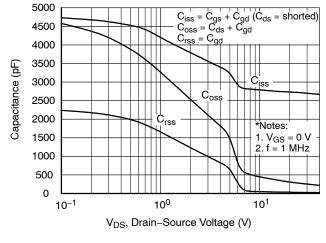


Figure 5. Capacitance Characteristics

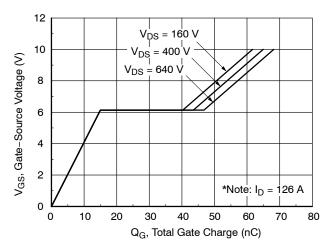


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS

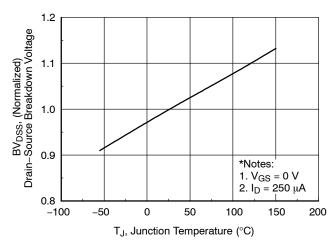


Figure 7. Breakdown Voltage Variation vs. Temperature

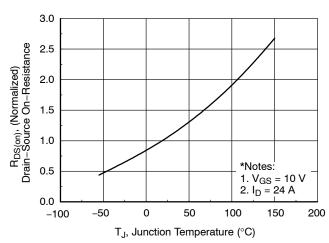


Figure 8. On-Resistance Variation vs. Temperature

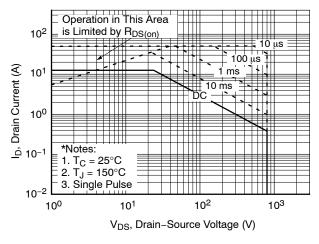


Figure 9. Maximum Safe Operating Area

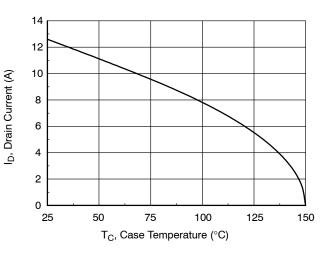


Figure 10. Maximum Drain Current vs. Case Temperature

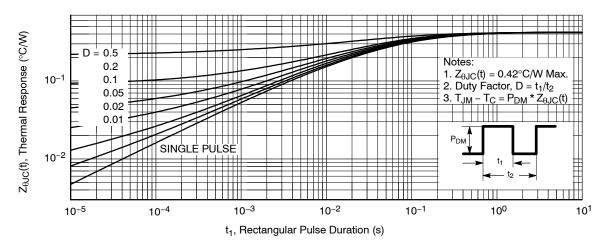


Figure 11. Transient Thermal Response Curve

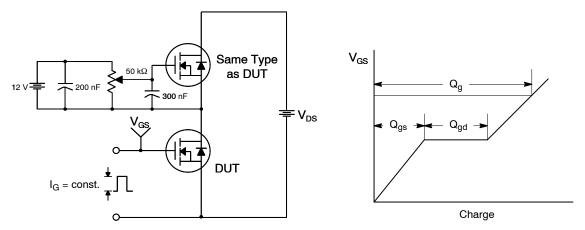


Figure 12. Gate Charge Test Circuit & Waveform

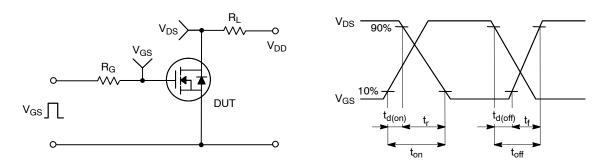


Figure 13. Resistive Switching Test Circuit & Waveforms

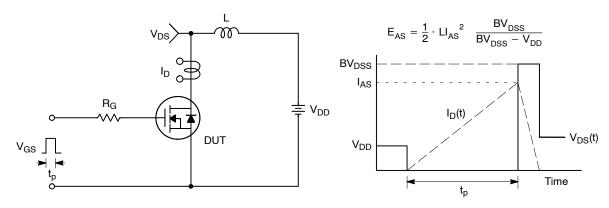
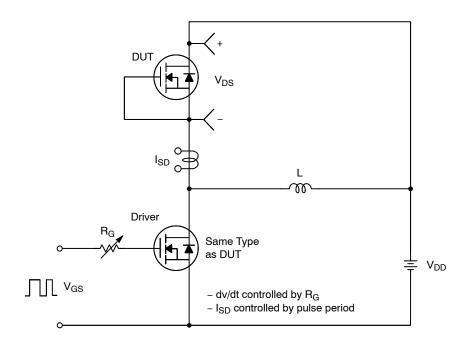


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



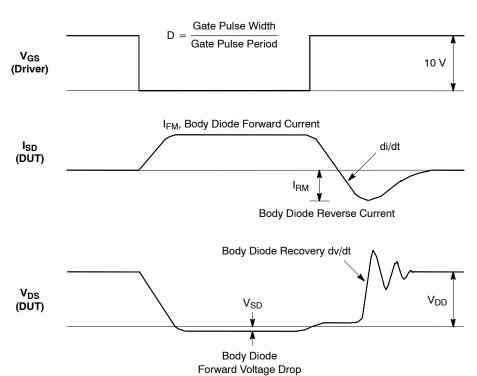


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

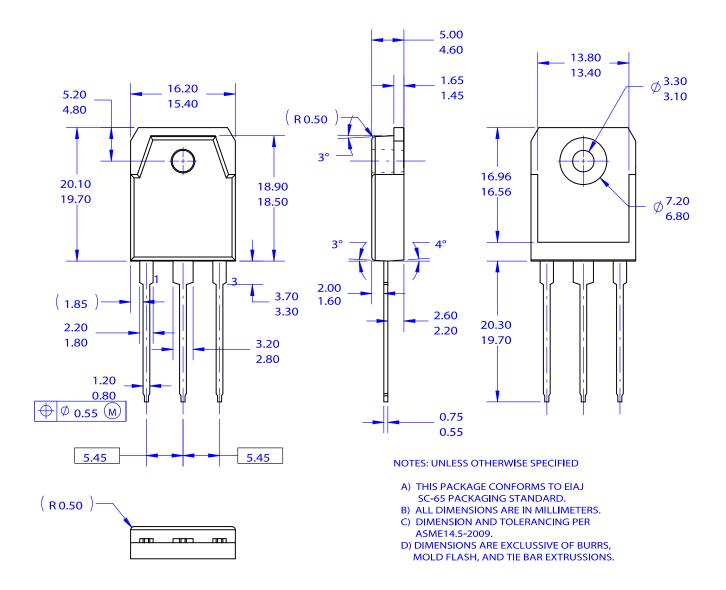
PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FQA13N80-F109	FQA13N80	TO-3P-3LD	Tube	N/A	N/A	450 Units /Tube



TO-3P-3LD / EIAJ SC-65, ISOLATED CASE 340BZ ISSUE O

DATE 31 OCT 2016



DOCUMENT NUMBER:	98AON13862G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	TO-3P-3LD / EIAJ SC-65, ISOLATED		PAGE 1 OF 1		

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi:

FQA13N80-F109